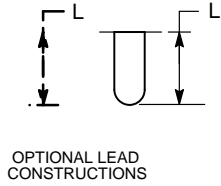
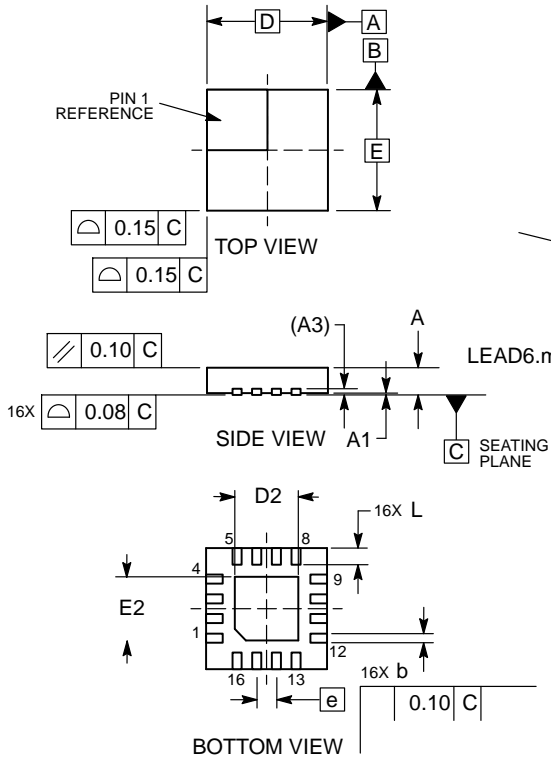




QFN16 4x4, 0.65P
CASE 485AP i01
ISSUE A

DATE 20 MAY 2009

SCALE 2:1

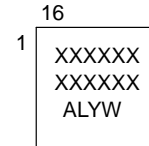


NOTES:

1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30 MM FROM TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

LEAD6.m 0-0 -0.019 0390 cm 015 5.CONSTRUCTIONS0 0 m 8 -.0003 Tw [-1.2 -1.13627270.142 566.70

GENERIC MARKING DIAGRAM*



- XXXX = Specific Device Code
 A = Assembly Location
 L = Wafer Lot
 Y = Year
 W = Work Week
 = Pb iFree Package

*This information is generic. Please refer to device data sheet for actual part marking. Pb iFree indicator, "G", may or not be present.

